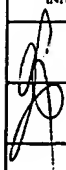
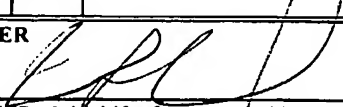
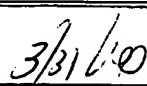


<b>LIST OF REFERENCES CITED BY APPLICANT</b> (Use several sheets if necessary)				ATTY. DOCKET NO.:		APPLICATION NO.:		
				4717-13000		10/827,437		
				APPLICANT:				
				Takeshi AKATSU				
				FILING DATE:		GROUP:		
				April 20, 2004		1765		
<b>U.S. PATENT DOCUMENTS</b>								
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	AA	6,524,935 B1	2/2003	Canaperi et al.	438	478		
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							YES	NO
	AD	EP 1 258 544 A1	11/2002	Europe			X	
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	AG	L. Huang et al., XP001116664 "Electron And Hole Mobility Enhancement In Strained SOI By Wafer Bonding", IEEE Transactions On Electron Devices, Vol. 49, No. 9, pp. 1566-1567 (2002).						
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*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.								

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					4717-13000		Not yet assigned	
					APPLICANT:			
					Takeshi AKATSU <i>et al.</i>			
					FILING DATE:		GROUP:	
					Filed concurrently herewith			
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<b>FOREIGN PATENT DOCUMENTS</b>								
	DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION		
						YES	NO	
	AK							
	AL							
	AM							
	AN							
	AO							
	AP							
<b>OTHER REFERENCES (Including Author, Title, Date, Pertinent Pages, Etc.)</b>								
	AQ							
	AR							
	AS							
	AT							
EXAMINER 				DATE CONSIDERED 				
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